

# FGPF120N30

## 300V, 120A PDP IGBT

### Features

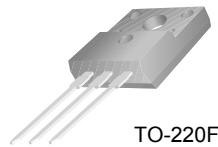
- High Current Capability
- Low saturation voltage :  $V_{CE(sat)} = 1.1\text{ V @ } I_C = 25\text{A}$
- High input impedance
- Fast switching

### General Description

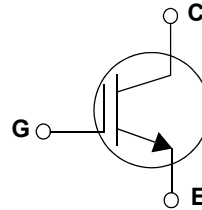
Employing Unified IGBT Technology, Fairchild's PWD series of IGBTs provides low conduction and switching loss. The PWD series offers the optimum solution for PDP applications where low conduction loss is essential.

### Application

PDP SYSTEM



TO-220F  
1.Gate 2.Collector 3.Emitter



### Absolute Maximum Ratings

Symbol	Description	FGPF120N30	Units
$V_{CES}$	Collector-Emitter Voltage	300	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_C$	Collector Current @ $T_C = 25^\circ\text{C}$	120	A
$I_{C\_pulse(1)}$	Pulse Collector Current @ $T_C = 25^\circ\text{C}$	180 *	A
$P_D$	Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	60	W
	Maximum Power Dissipation @ $T_C = 100^\circ\text{C}$	24	W
$T_J$	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$
$T_{stg}$	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}(\text{IGBT})$	Thermal Resistance, Junction-to-Case	--	2.1	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	--	62.5	$^\circ\text{C/W}$

### Notes

(1) Repetitive test , pulse width=100usec , Duty=0.5

\*  $I_{C\_pulse}$  limited by max  $T_J$

## Package Marking and Ordering Information

Device Marking	Device	Package	Packaging Type	Qty per Tube	Max Qty per Box
FGPF120N30	FGPF120N30TU	TO-220F	Rail / Tube	50ea	-

## Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
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### Off Characteristics

BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	300	--	--	V
ΔBV <sub>CES</sub> /ΔT <sub>J</sub>	Temperature Coefficient of Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	--	0.6	--	V/°C
I <sub>CES</sub>	Collector Cut-Off Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V	--	--	100	uA
I <sub>GES</sub>	G-E Leakage Current	V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V	--	--	± 250	nA

### On Characteristics

V <sub>GE(th)</sub>	G-E Threshold Voltage	I <sub>C</sub> = 250uA, V <sub>CE</sub> = V <sub>GE</sub>	2.5	4.0	5.0	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 25A, V <sub>GE</sub> = 15V	--	1.1	1.4	V
		I <sub>C</sub> = 120A, V <sub>GE</sub> = 15V T <sub>C</sub> = 25°C	--	1.9	--	V
		I <sub>C</sub> = 120 A, V <sub>GE</sub> = 15V T <sub>C</sub> = 125°C	--	2.1	--	V

### Dynamic Characteristics

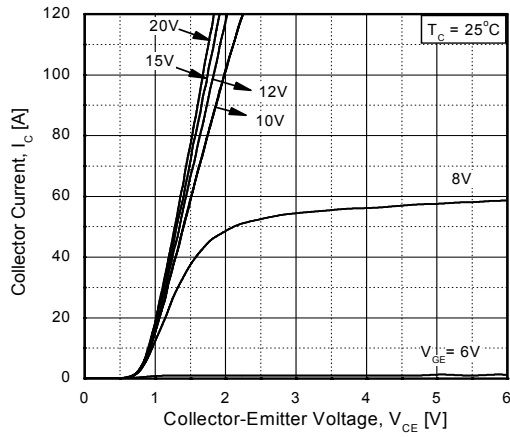
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz	--	2190	--	pF
C <sub>oes</sub>	Output Capacitance		--	310	--	pF
C <sub>res</sub>	Reverse Transfer Capacitance		--	98	--	pF

### Switching Characteristics

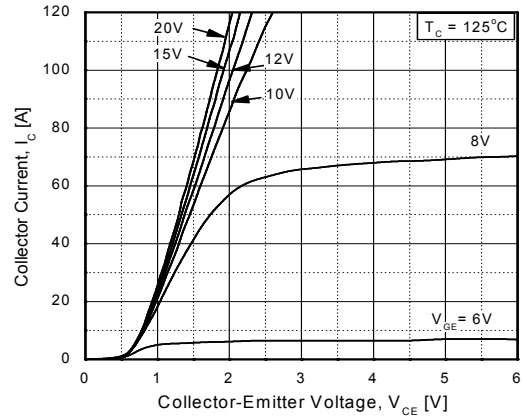
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>CC</sub> = 200 V, I <sub>C</sub> = 25A, R <sub>G</sub> = 8.7Ω, V <sub>GE</sub> = 15V, Resistive Load, T <sub>C</sub> = 25°C	--	35	--	ns
t <sub>r</sub>	Rise Time		--	140	--	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	120	--	ns
t <sub>f</sub>	Fall Time		--	140	350	ns
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>CC</sub> = 200 V, I <sub>C</sub> = 25 A, R <sub>G</sub> = 8.7Ω, V <sub>GE</sub> = 15V, Resistive Load, T <sub>C</sub> = 125°C	--	35	--	ns
t <sub>r</sub>	Rise Time		--	140	--	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		--	130	--	ns
t <sub>f</sub>	Fall Time		--	280	--	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>CE</sub> = 200 V, I <sub>C</sub> = 25A, V <sub>GE</sub> = 15V	--	112	168	nC
Q <sub>ge</sub>	Gate-Emitter Charge		--	14	21	nC
Q <sub>gc</sub>	Gate-Collector Charge		--	50	75	nC

## Typical Performance Characteristics

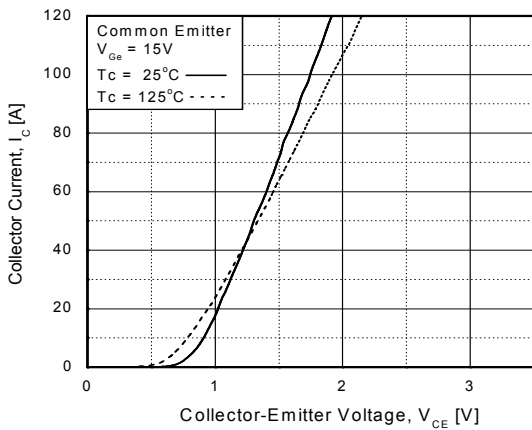
**Figure 1. Typical Output Characteristics**



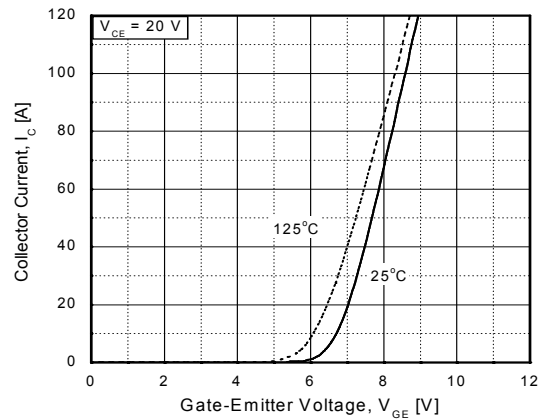
**Figure 2. Typical Output Characteristics**



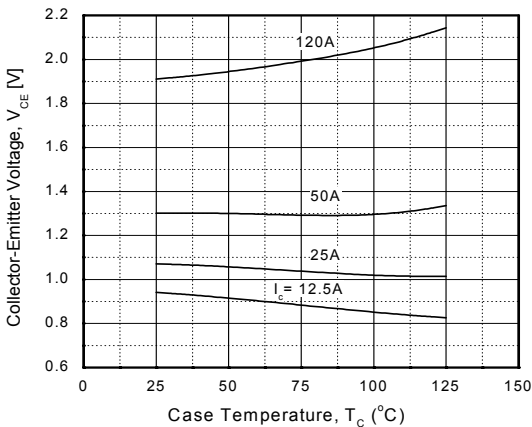
**Figure 3 Typical Saturation Voltage Characteristics**



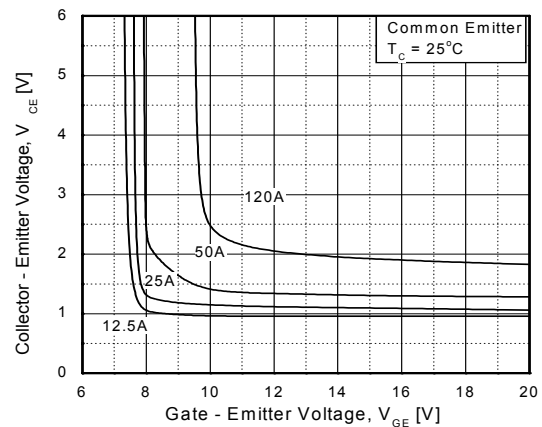
**Figure 4. Transfer Characteristics**



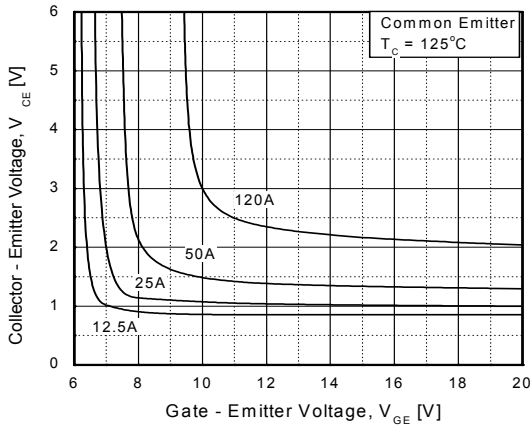
**Figure 5. Saturation Voltage vs Case Temperature at Variant Current Level**



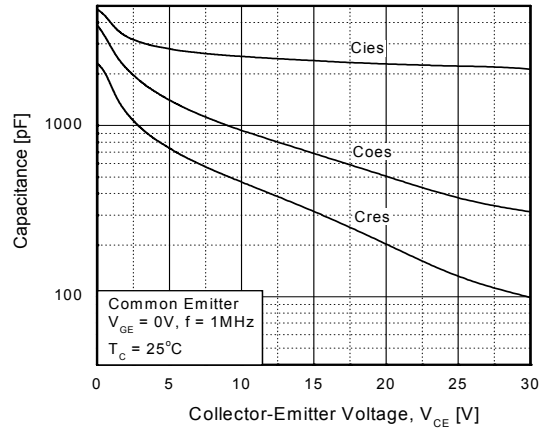
**Figure 6. Saturation Voltage vs. Vge**



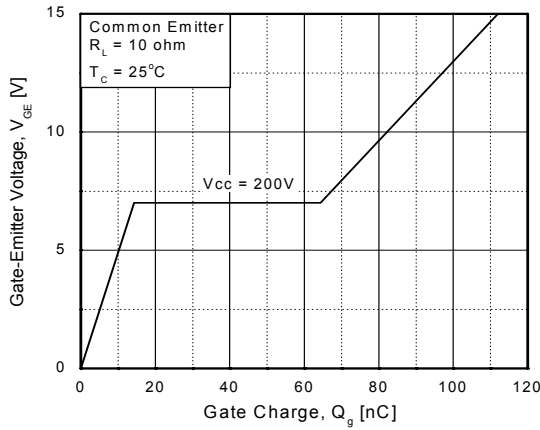
**Figure 7. Saturation Voltage vs. V<sub>GE</sub>**



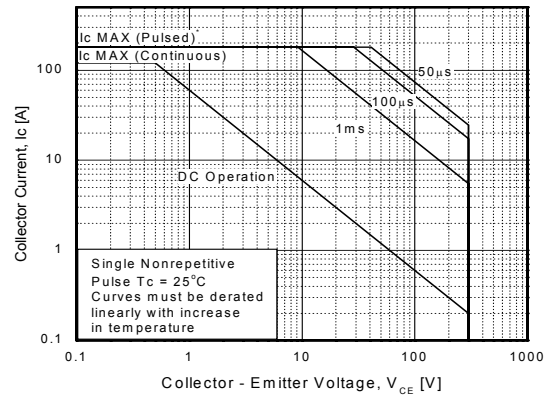
**Figure 8. Capacitance Characteristics**



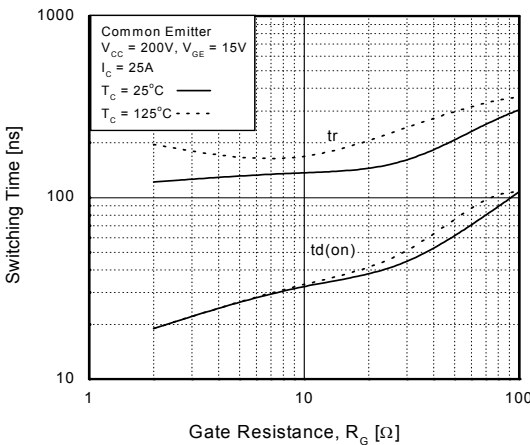
**Figure 9. Gate Charge**



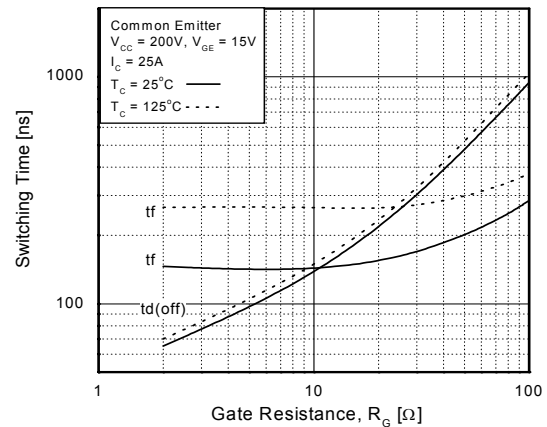
**Figure 10. SOA Characteristics**



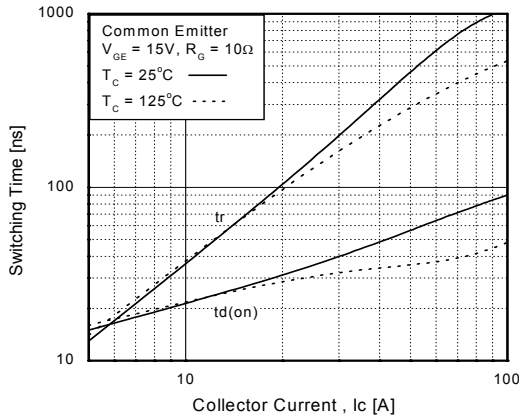
**Figure 11. Turn-On Characteristics vs. Gate Resistance**



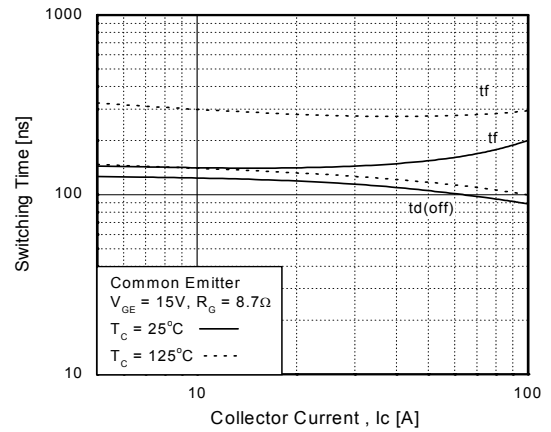
**Figure 12. Turn-Off Characteristics vs. Gate Resistance**



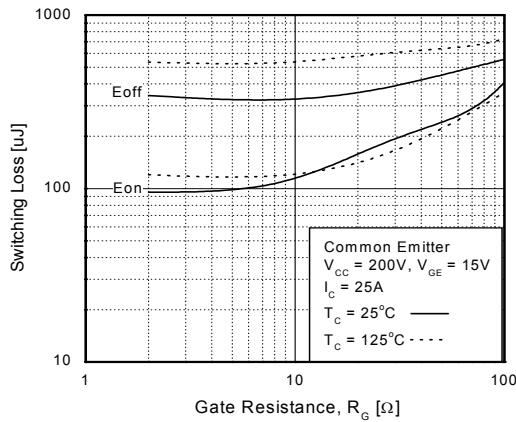
**Figure 13 Turn-On Characteristics vs. Collector Current**



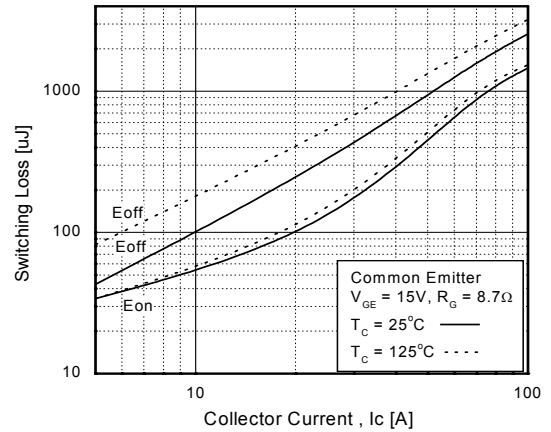
**Figure 14. Turn-Off Characteristics vs. Collector Current**



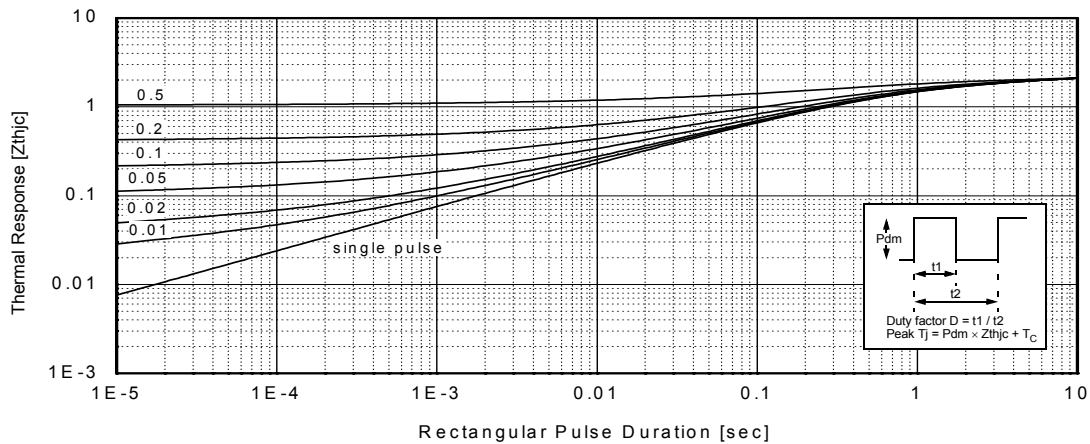
**Figure 15. Switching Loss vs. Gate Resistance**



**Figure 16. Switching Loss vs. Collector Current**

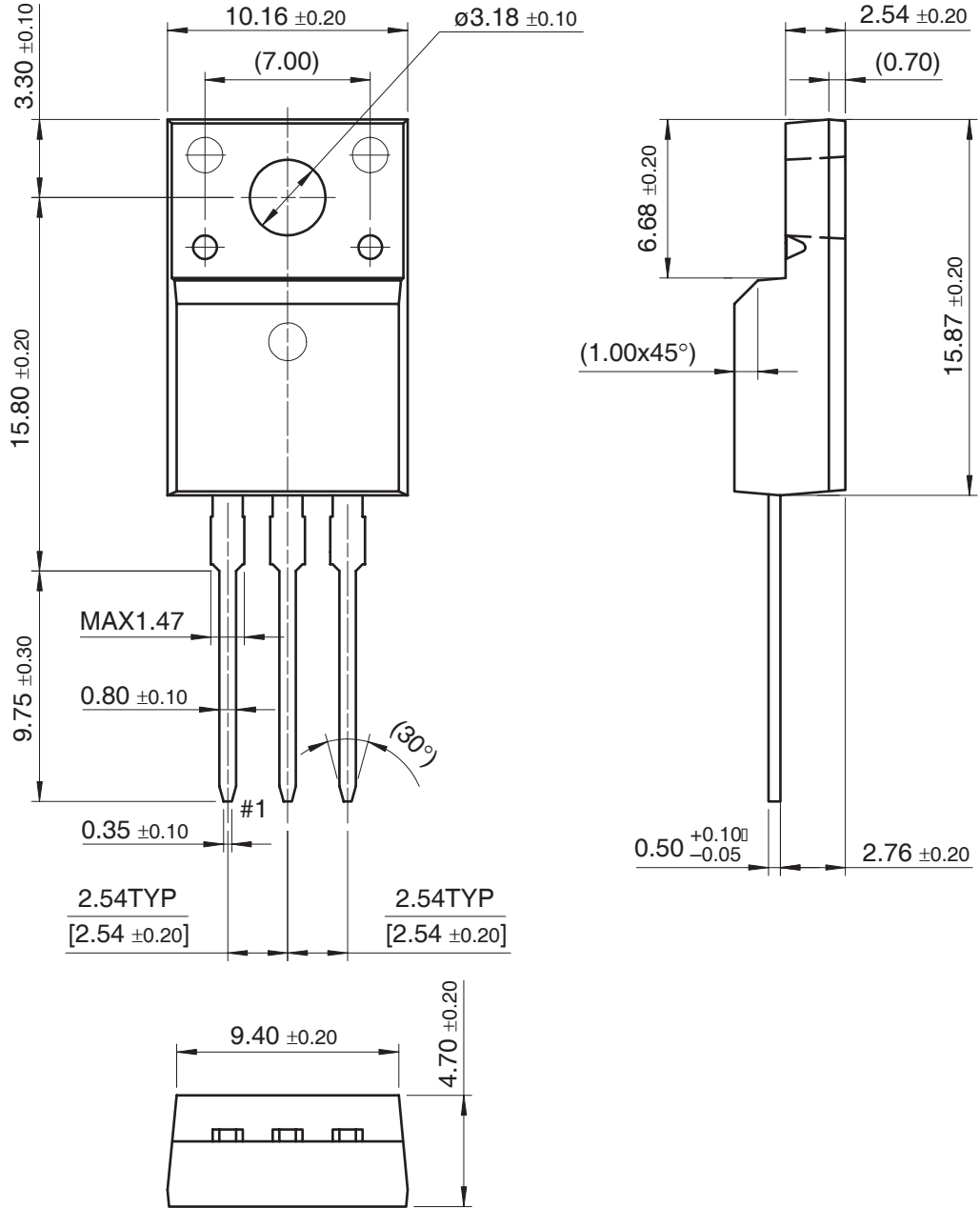


**Figure 17. Transient Thermal Impedance of IGBT**



Mechanical Dimensions

TO-220F



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